

SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93 DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS

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'90A, 'LS90 . . . Decade Counters

'92A, 'LS92 . . . Divide By-Twelve Counters

'93A, 'LS93 . . . 4-Bit Binary Counters

TYPES	TYPICAL POWER DISSIPATION
'90A	145 mW
'92A, '93A	130 mW
'LS90, 'LS92, 'LS93	45 mW

description

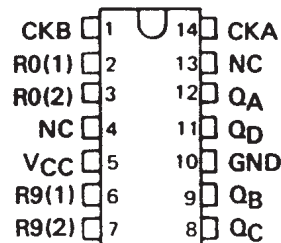
Each of these monolithic counters contains four master-slave flip-flops and additional gating to provide a divide-by-two counter and a three-stage binary counter for which the count cycle length is divide-by-five for the '90A and 'LS90, divide-by-six for the '92A and 'LS92, and the divide-by-eight for the '93A and 'LS93.

All of these counters have a gated zero reset and the '90A and 'LS90 also have gated set-to-nine inputs for use in BCD nine's complement applications.

To use their maximum count length (decade, divide-by-twelve, or four-bit binary) of these counters, the CKB input is connected to the Q_A output. The input count pulses are applied to CKA input and the outputs are as described in the appropriate function table. A symmetrical divide-by-ten count can be obtained from the '90A or 'LS90 counters by connecting the Q_D output to the CKA input and applying the input count to the CKB input which gives a divide-by-ten square wave at output Q_A .

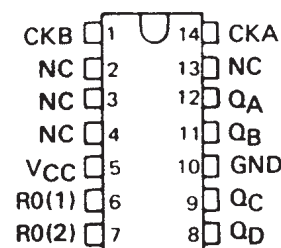
SN5490A, SN54LS90 . . . J OR W PACKAGE
SN7490A . . . N PACKAGE
SN74LS90 . . . D OR N PACKAGE

(TOP VIEW)



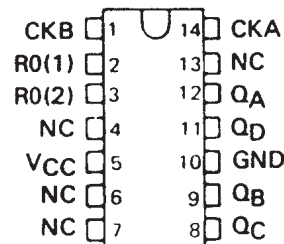
SN5492A, SN54LS92 . . . J OR W PACKAGE
SN7492A . . . N PACKAGE
SN74LS92 . . . D OR N PACKAGE

(TOP VIEW)



SN5493A, SN54LS93 . . . J OR W PACKAGE
SN7493 . . . N PACKAGE
SN74LS93 . . . D OR N PACKAGE

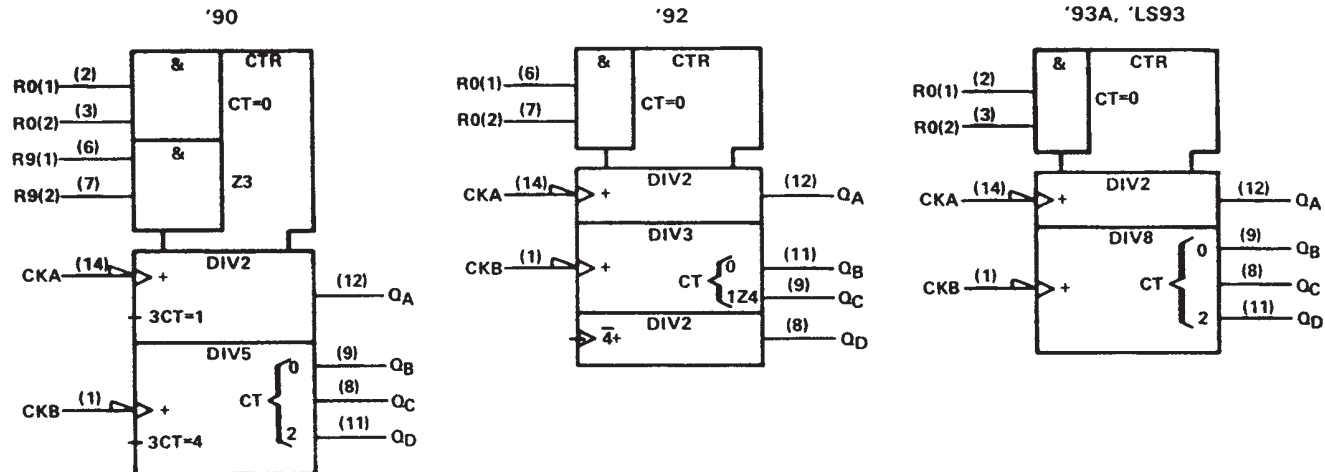
(TOP VIEW)



**SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93
SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93
DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS**

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logic symbols†



†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93
 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93
 DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS

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'90A, 'LS90
 BCD COUNT SEQUENCE
 (See Note A)

COUNT	OUTPUT			
	Q _D	Q _C	Q _B	Q _A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H

'90A, 'LS90
 BI-QUINARY (5-2)
 (See Note B)

COUNT	OUTPUT			
	Q _A	Q _D	Q _C	Q _B
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	H	L	L	L
6	H	L	L	H
7	H	L	H	L
8	H	L	H	H
9	H	H	L	L

'92A, 'LS92
 COUNT SEQUENCE
 (See Note C)

COUNT	OUTPUT			
	Q _D	Q _C	Q _B	Q _A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	H	L	L	L
7	H	L	L	H
8	H	L	H	L
9	H	L	H	H
10	H	H	L	L
11	H	H	L	H

'90A, 'LS90
 RESET/COUNT FUNCTION TABLE

RESET INPUTS				OUTPUT			
R ₀ (1)	R ₀ (2)	R ₉ (1)	R ₉ (2)	Q _D	Q _C	Q _B	Q _A
H	H	L	X	L	L	L	L
H	H	X	L	L	L	L	L
X	X	H	H	H	L	L	H
X	L	X	L	COUNT			
L	X	L	X	COUNT			
L	X	X	L	COUNT			
X	L	L	X	COUNT			

'93A, 'LS93
 COUNT SEQUENCE
 (See Note C)

COUNT	OUTPUT			
	Q _D	Q _C	Q _B	Q _A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

'92A, 'LS92, '93A, 'LS93
 RESET/COUNT FUNCTION TABLE

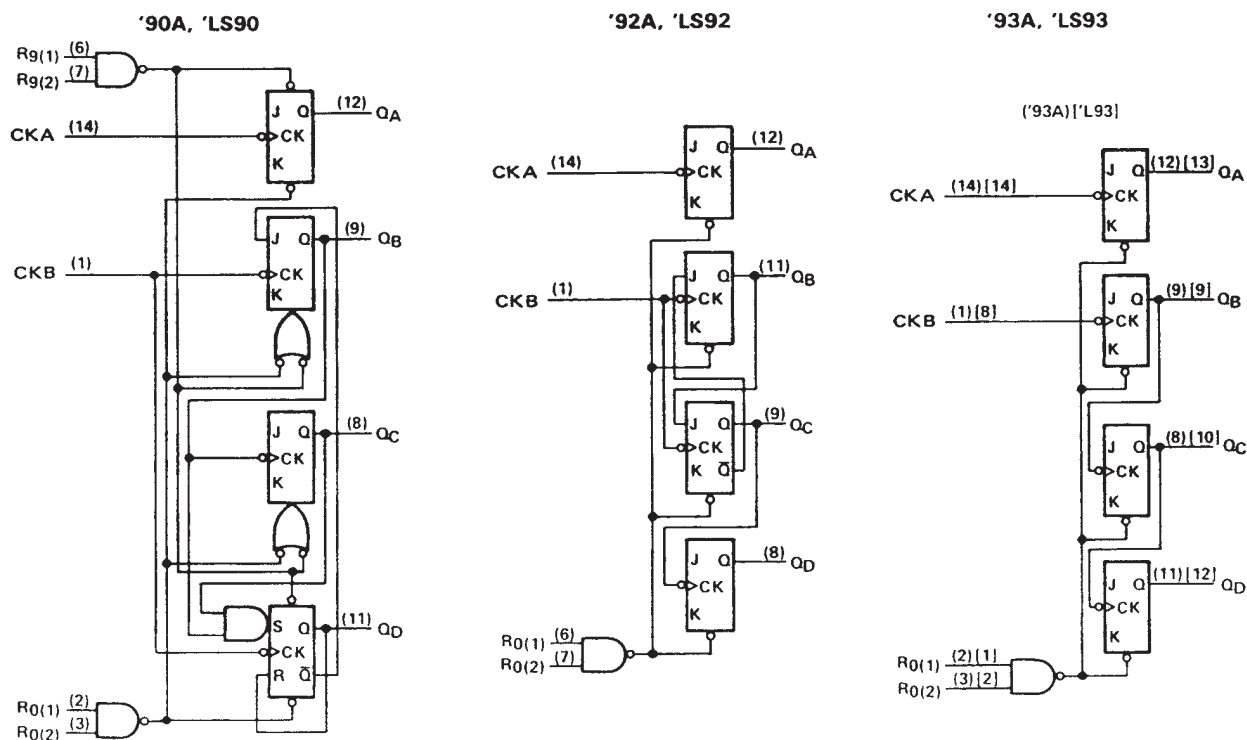
RESET INPUTS		OUTPUT			
R ₀ (1)	R ₀ (2)	Q _D	Q _C	Q _B	Q _A
H	H	L	L	L	L
L	X	COUNT			
X	L	COUNT			

- NOTES: A. Output Q_A is connected to input CKB for BCD count.
 B. Output Q_D is connected to input CKA for bi-quinary count.
 C. Output Q_A is connected to input CKB.
 D. H = high level, L = low level, X = irrelevant

SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93 DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS

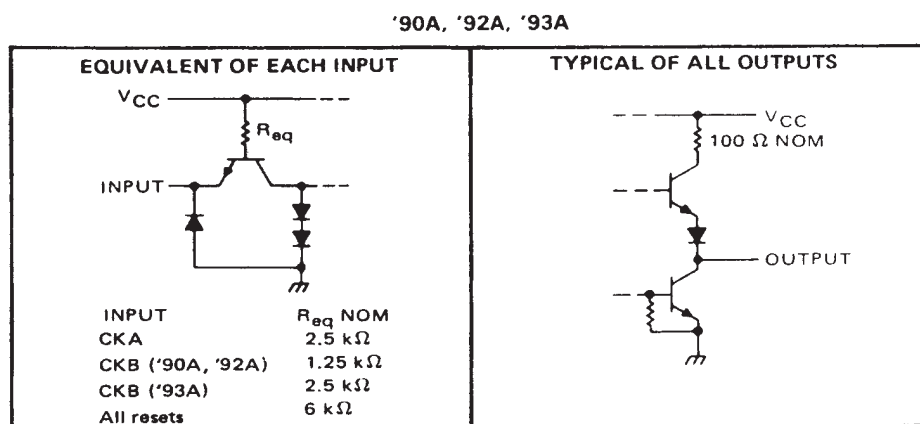
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logic diagrams (positive logic)



The J and K inputs shown without connection are for reference only and are functionally at a high level.
Pin numbers shown in () are for the 'LS93 and '93A and pin numbers shown in [] are for the 54L93.

schematics of inputs and outputs

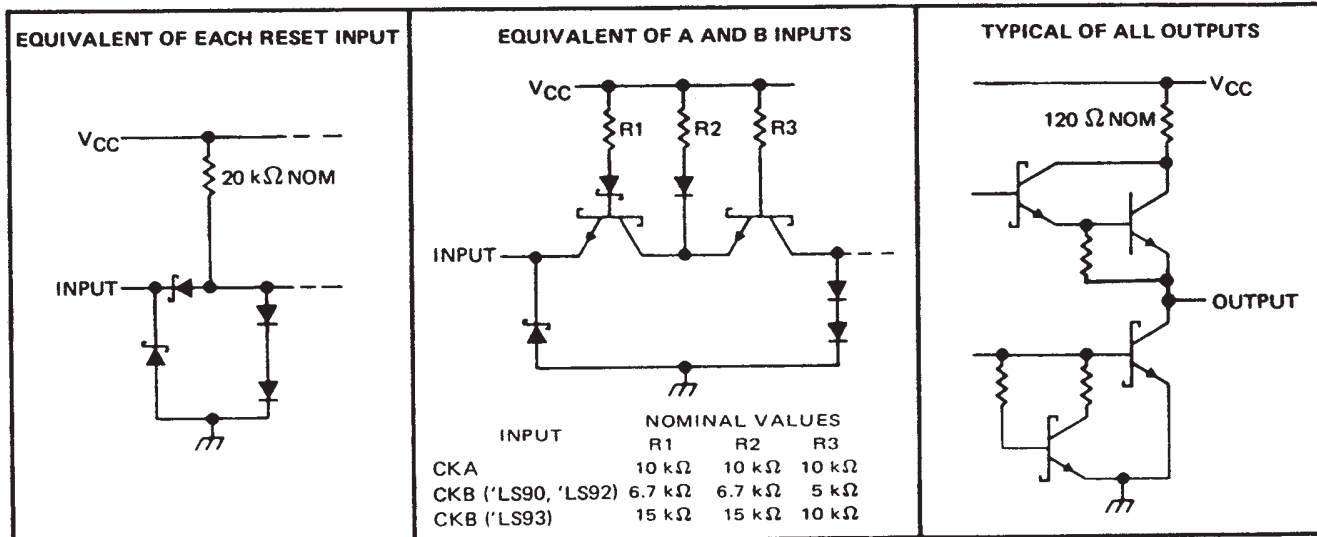


SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93
 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93
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schematics of inputs and outputs (continued)

'LS90, 'LS92, 'LS93



SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93 DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage	5.5 V
Interemitter voltage (see Note 2)	5.5 V
Operating free-air temperature range: SN5490A, SN5492A, SN5493A	–55°C to 125°C
SN7490A, SN7492A, SN7493A	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

2. This is the voltage between two emitters of a multiple-emitter transistor. For these circuits, this rating applies between the two R_0 inputs, and for the '90A circuit, it also applies between the two R_0 inputs.

recommended operating conditions

		SN5490A, SN5492A SN5493A			SN7490A, SN7492A SN7493A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				–800			–800	μ A
Low-level output current, I_{OL}				16			16	mA
Count frequency, f_{count} (see Figure 1)	A input	0		32	0		32	MHz
	B input	0		16	0		16	
Pulse width, t_w	A input	15			15			ns
	B input	30			30			
	Reset inputs	15			15			
Reset inactive-state setup time, t_{SU}		25			25			ns
Operating free-air temperature, T_A		–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER ¶		TEST CONDITIONS†		'90A			'92A			'93A			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IH}	High-level input voltage			2			2			2			V
V _{IL}	Low-level input voltage			0.8			0.8			0.8			V
V _{IK}	Input clamp voltage	V _{CC} = MIN, I _I = –12 mA		–1.5			–1.5			–1.5			V
V _{OH}	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = –800 µA		2.4	3.4		2.4	3.4		2.4	3.4		V
V _{OL}	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA¶			0.2	0.4		0.2	0.4		0.2	0.4	V
I _I	Input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V		1			1			1			mA
I _{IH}	High-level input current	Any reset	V _{CC} = MAX, V _I = 2.4 V	40			40			40			µA
		CKA		80			80			80			
		CKB		120			120			80			
I _{IL}	Low-level input current	Any reset	V _{CC} = MAX, V _I = 0.4 V	–1.6			–1.6			–1.6			mA
		CKA		–3.2			–3.2			–3.2			
		CKB		–4.8			–4.8			–3.2			
I _{OS}	Short-circuit output current §	V _{CC} = MAX	SN54'	–20	–57	–20	–57	–20	–57				mA
			SN74'	–18	–57	–18	–57	–18	–57				
I _{CC}	Supply current	V _{CC} = MAX, See Note 3			29	42		26	39		26	39	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

[§] Not more than one output should be shorted at a time.

[¶] I_{OH} outputs are tested at $I_{OL} = 16 \text{ mA}$ plus the limit value for I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

NOTE 3: I_{CC} is measured with all outputs open, both R_0 inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.



SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93
 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93
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switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'90A			'92A			'93A			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
f _{max}	CKA	Q _A	C _L = 15 pF, R _L = 400 Ω, See Figure 1	32	42		32	42		32	42		MHz
	CKB	Q _B		16			16			16			
t _{PLH}	CKA	Q _A		10	16		10	16		10	16		ns
t _{PHL}				12	18		12	18		12	18		
t _{PLH}	CKA	Q _D		32	48		32	48		46	70		ns
t _{PHL}				34	50		34	50		46	70		
t _{PLH}	CKB	Q _B		10	16		10	16		10	16		ns
t _{PHL}				14	21		14	21		14	21		
t _{PLH}	CKB	Q _C		21	32		10	16		21	32		ns
t _{PHL}				23	35		14	21		23	35		
t _{PLH}	CKB	Q _D		21	32		21	32		34	51		ns
t _{PHL}				23	35		23	35		34	51		
t _{PHL}	Set-to-0	Any		26	40		26	40		26	40		ns
t _{PLH}	Set-to-9	Q _A , Q _D		20	30								ns
t _{PHL}		Q _B , Q _C		26	40								

† $f_{\max}$ = maximum count frequency

t_{PLH} = propagation delay time, low-to-high-level output

t_{PHL} = propagation delay time, high-to-low-level output



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SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93 DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage: R inputs	7 V
A and B inputs	5.5 V
Operating free-air temperature range: SN54LS* Circuits	–55°C to 125°C
SN74LS* Circuits	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS90 SN54LS92 SN54LS93			SN74LS90 SN74LS92 SN74LS93			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}		–400			–400			μ A
Low-level output current, I_{OL}		4			8			mA
Count frequency, f_{count} (see Figure 1)	A input	0		32	0		32	MHz
	B input	0		16	0		16	
Pulse width, t_w	A input	15			15			ns
	B input	30			30			
	Reset inputs	30			30			
Reset inactive-state setup time, t_{su}		25			25			ns
Operating free-air temperature, T_A		–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS90 SN54LS92			SN74LS90 SN74LS92			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.7			0.8	V
V_{IK}	Input clamp voltage	$V_{CC} = \text{MIN}, I_I = -18 \text{ mA}$				–1.5			–1.5	V
V_{OH}	High-level output voltage	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = V_{IL \text{ max}}, I_{OH} = -400 \mu\text{A}$		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = V_{IL \text{ max}}, I_{OL} = 4 \text{ mA}^{\S}$		0.25	0.4		0.25	0.4		V
		$I_{OL} = 8 \text{ mA}^{\S}$					0.35	0.5		
I_I	Input current at maximum input voltage	Any reset	$V_{CC} = \text{MAX}, V_I = 7 \text{ V}$			0.1			0.1	mA
		CKA	$V_{CC} = \text{MAX}, V_I = 5.5 \text{ V}$			0.2			0.2	
		CKB				0.4			0.4	
I_{IH}	High-level input current	Any reset	$V_{CC} = \text{MAX}, V_I = 2.7 \text{ V}$			20			20	μ A
		CKA				40			40	
		CKB				80			80	
I_{IL}	Low-level input current	Any reset	$V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}$			–0.4			–0.4	mA
		CKA				–2.4			–2.4	
		CKB				–3.2			–3.2	
I_{OS}	Short-circuit output current §	$V_{CC} = \text{MAX}$		–20		–100	–20		–100	mA
I_{CC}	Supply current	$V_{CC} = \text{MAX},$ See Note 3	'LS90			9			15	mA
			'LS92			9			15	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

§ I_{QA} outputs are tested at specified I_{OL} plus the limit value of I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

NOTE 3: I_{CC} is measured with all outputs open, both R_O inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.



SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93
SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93
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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	SN54LS93			SN74LS93			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IH}	High-level input voltage			2			2			V
V _{IL}	Low-level input voltage					0.7			0.8	V
V _{IK}	Input clamp voltage		V _{CC} = MIN, I _I = -18 mA			-1.5			-1.5	V
V _{OH}	High-level output voltage		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = V _{IL max} , I _{OH} = -400 µA	2.5	3.4		2.7	3.4		V
V _{OL}	Low-level output voltage		V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 4 mA¶	0.25	0.4		0.25	0.4		V
			V _{IL} = V _{IL max} , I _{OL} = 8 mA¶				0.35	0.5		
I _I	Input current at maximum input voltage	Any reset	V _{CC} = MAX, V _I = 7 V			0.1			0.1	mA
		CKA or CKB	V _{CC} = MAX, V _I = 5.5 V			0.2			0.2	
I _{IH}	High-level input current	Any reset	V _{CC} = MAX, V _I = 2.7 V			20			20	µA
		CKA or CKB				40			80	
I _{IL}	Low-level input current	Any reset	V _{CC} = MAX, V _I = 0.4 V			-0.4			-0.4	mA
		CKA				-2.4			-2.4	
		CKB				-1.6			-1.6	
I _{OS}	Short-circuit output current§		V _{CC} = MAX	-20		-100	-20		-100	mA
I _{CC}	Supply current		V _{CC} = MAX, See Note 3	9	15		9	15		mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at V_{CC} = 5 V, T_A = 25°C.

§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

¶Q_A outputs are tested at specified I_{OL} plus the limit value for I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

NOTE 3: I_{CC} is measured with all outputs open, both R_Q inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER#	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS90			'LS92			'LS93			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
f _{max}	CKA	Q _A	C _L = 15 pF, R _L = 2 kΩ See Figure 1	32	42		32	42		32	42		MHz
	CKB	Q _B		16			16			16			
t _{PLH}	CKA	Q _A		10	16		10	16		10	16		ns
t _{PHL}				12	18		12	18		12	18		
t _{PLH}	CKA	Q _D		32	48		32	48		46	70		ns
t _{PHL}				34	50		34	50		46	70		
t _{PLH}	CKB	Q _B		10	16		10	16		10	16		ns
t _{PHL}				14	21		14	21		14	21		
t _{PLH}	CKB	Q _C		21	32		10	16		21	32		ns
t _{PHL}				23	35		14	21		23	35		
t _{PLH}	CKB	Q _D		21	32		21	32		34	51		ns
t _{PHL}				23	35		23	35		34	51		
t _{PHL}	Set-to-0	Any		26	40		26	40		26	40		ns
t _{PLH}	Set-to-9	Q _A , Q _D		20	30								ns
t _{PHI}		Q _B , Q _C		26	40								

#f_{max} = maximum count frequency

t_{PLH} = propagation delay time, low-to-high-level output

t_{PHL} = propagation delay time, high-to-low-level output



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SN5490A, SN5492A, SN5493A, SN54LS90, SN54LS92, SN54LS93 SN7490A, SN7492A, SN7493A, SN74LS90, SN74LS92, SN74LS93 DECADE, DIVIDE-BY-TWELVE AND BINARY COUNTERS

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. Input pulses are supplied by a generator having the following characteristics:

for '90A, '92A, '93A, $t_r \leq 5$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms;
for 'LS90, 'LS92, 'LS93, $t_r \leq 15$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms.

B. C_L includes probe and jig capacitance.

C. All diodes are 1N3064 or equivalent.

D. Each reset input is tested separately with the other reset at 4.5 V.

E. Reference waveforms are shown with dashed lines.

F. For '90A, '92A, and '93A; $V_{ref} = 1.5$ V. For 'LS90, 'LS92, and 'LS93; $V_{ref} = 1.3$ V.

FIGURE 1A

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. Input pulses are supplied by a generator having the following characteristics:
for '90A, '92A, '93A, $t_r \leq 5$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms;
for 'LS90, 'LS92, 'LS93, $t_r \leq 15$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms.
- B. C_L includes probe and jig capacitance.
- C. All diodes are 1N3064 or equivalent.
- D. Each reset input is tested separately with the other reset at 4.5 V.
- E. Reference waveforms are shown with dashed lines.
- F. For '90A, '92A, and '93A; $V_{ref} = 1.5$ V. For 'LS90, 'LS92, and 'LS93; $V_{ref} = 1.3$ V.

FIGURE 1B

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
7603201CA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Call TI	
7603201DA	ACTIVE	CFP	W	14	1	TBD	Call TI	Call TI	
7700101CA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Call TI	
7700101DA	ACTIVE	CFP	W	14	1	TBD	Call TI	Call TI	
JM38510/31501BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
JM38510/31501BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	
JM38510/31502BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
JM38510/31502BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	
M38510/31501BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
M38510/31501BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	
M38510/31502BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
M38510/31502BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	
SN5490AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	
SN5492AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	
SN54LS90J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
SN54LS93J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
SN7490AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	
SN7492AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	
SN7493AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	
SN74LS90D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS90DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS90DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS90DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS90DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS90DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN74LS90N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS90NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS92D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS92DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS92DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS92N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS92N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	
SN74LS92NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS92NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS92NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS92NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS93D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS93DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS93DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS93N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS93N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	
SN74LS93NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74LS93NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS93NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SN74LS93NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	
SNJ5490AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	
SNJ5490AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI	

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SNJ5492AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	
SNJ5492AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI	
SNJ54LS90J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
SNJ54LS90W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	
SNJ54LS93J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	
SNJ54LS93W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN5490A, SN5492A, SN54LS90, SN54LS93, SN7490A, SN7492A, SN74LS90, SN74LS93 :

- Catalog: [SN7490A](#), [SN7492A](#), [SN74LS90](#), [SN74LS93](#)

- Military: [SN5490A](#), [SN5492A](#), [SN54LS90](#), [SN54LS93](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS

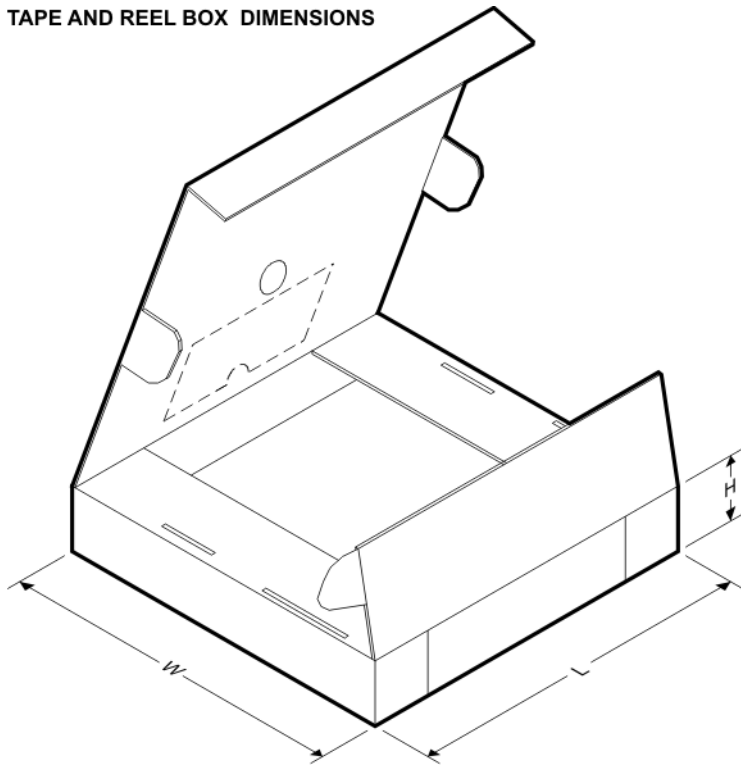

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS90DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS92NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS93NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS90DR	SOIC	D	14	2500	367.0	367.0	38.0
SN74LS92NSR	SO	NS	14	2000	367.0	367.0	38.0
SN74LS93NSR	SO	NS	14	2000	367.0	367.0	38.0

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

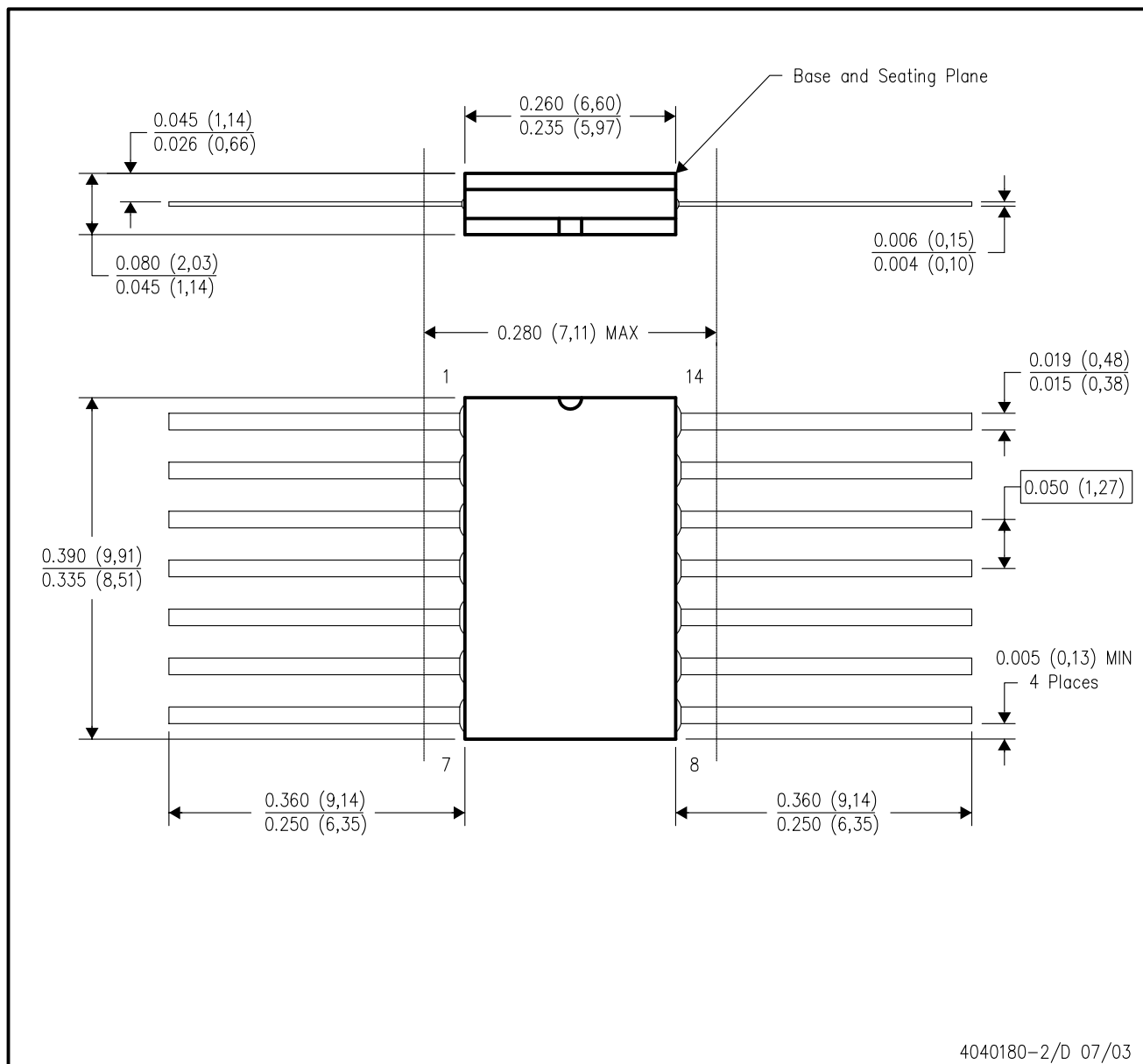


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK

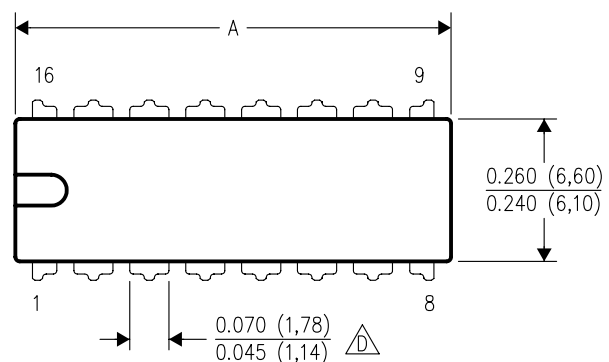


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only.
 - Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

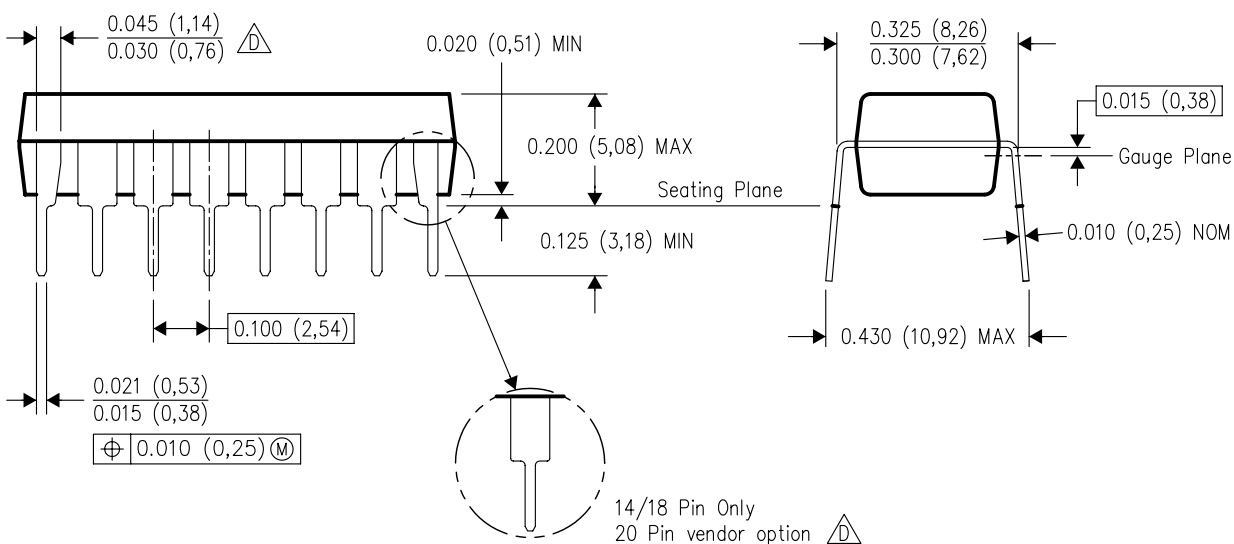
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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